# THERMOANALYTICAL STUDY ON THE REACTION OF THE CuO-Al<sub>2</sub>O<sub>3</sub>( $\eta$ ,  $\gamma$  AND  $\alpha$ ) SYSTEMS

TAKESHI TSUCHIDA, RYUSABURO FURUICHI, TSUNEYUKI SUKEGAWA, MASAKI FURUDATE and TADAO ISHII

*Department of Applied Chemistry, Faculty of Engineering, Hokkaido University, Sapporo, 060 (Japan)* 

(Received 2 February 1984)

## ABSTRACT

The reaction processes proceeding in the CuO-A1<sub>2</sub>O<sub>1</sub>( $\eta$ ,  $\gamma$  and  $\alpha$ ) systems were investigated by means of TG, DTA and high-temperature X-ray diffraction. In the CuO- $\eta$ -Al<sub>2</sub>O<sub>1</sub> and CuO- $\gamma$ -Al<sub>2</sub>O<sub>3</sub> systems, the formation of 80% CuAl<sub>2</sub>O<sub>4</sub> (reaction 1) occurred on heating to 1000°C. The resulting CuAl<sub>2</sub>O<sub>4</sub> decomposed to CuAlO<sub>2</sub>, Al<sub>2</sub>O<sub>3</sub> and O<sub>2</sub> (reaction 2) in the temperature range  $1130-1230$ °C. The incongruent melting of CuAlO<sub>2</sub> (reaction 3) occurred at about 1250°C. On the other hand, the CuO- $\alpha$ -Al<sub>2</sub>O<sub>3</sub> system did not show the formation of CuAl<sub>2</sub>O<sub>4</sub> on heating to 1000°C, and CuO decomposed to Cu<sub>2</sub>O (reaction 4) at 1045°C and then the resulting Cu<sub>2</sub>O reacted with  $\alpha$ -Al<sub>2</sub>O<sub>3</sub> to form CuAlO<sub>2</sub> (reaction 5). The difference in reaction process between the CuO- $\eta$ -Al<sub>2</sub>O<sub>3</sub>, CuO- $\gamma$ -Al<sub>2</sub>O<sub>3</sub> and CuO- $\alpha$ -Al<sub>2</sub>O<sub>3</sub> systems can be attributed to the reactivity of  $\eta$ -,  $\gamma$ - and  $\alpha$ -Al<sub>2</sub>O<sub>3</sub> in CuAl<sub>2</sub>O<sub>4</sub> formation.



#### INTRODUCTION

According to the phase diagram of the copper oxide-alumina system [1-3], it is known that two aluminates, i.e., CuAl<sub>2</sub>O<sub>4</sub> and CuAlO<sub>2</sub>, form at high temperatures. CuAl<sub>2</sub>O<sub>4</sub> has a partly inverse spinel structure ( $\lambda = 0.20$ ) [4]), which belongs to the cubic space group (Fd3m,  $O_h^7$  and  $a = 8.08$  Å [5]) without tetragonal distortion. The structure of CuAlO, belongs to the rhombohedral system ( $D_3^5d$ -R $\overline{3}$ m) with  $a = 5.896$  Å and  $\alpha = 28.1^\circ$  [6]. Only one communication by Bessonov et al. [7] has reported the formation process of these aluminates. They investigated the reactions in the copper oxide-alumina system by using the high-temperature X-ray diffraction technique. The fundamental study on the kinetics and mechanism of the reactions in the copper oxide-alumina system is important in connection with the practical problem of the corrosion of alumina refractories in copper smelting furnaces.

The purpose of the present study is to investigate the reaction process occurring in the CuO- $\eta$ -Al<sub>2</sub>O<sub>3</sub>, CuO- $\gamma$ -Al<sub>2</sub>O<sub>3</sub> and CuO- $\alpha$ -Al<sub>2</sub>O<sub>3</sub> systems during heating to 1300°C and to discuss the reactivity of  $\eta$ -,  $\gamma$ - and  $\alpha$ -Al<sub>2</sub>O<sub>3</sub>.

## EXPERIMENTAL

 $\eta$ -Al<sub>2</sub>O<sub>3</sub> and  $\alpha$ -Al<sub>2</sub>O<sub>3</sub> were prepared by calcining bayerite ( $\beta$ -Al<sub>2</sub>O<sub>3</sub> · 3 H<sub>2</sub>O) at 700 and 1300°C for 3 h in air, respectively.  $\gamma$ -Al<sub>2</sub>O<sub>3</sub> was prepared by calcining boehmite ( $\alpha$ -Al<sub>2</sub>O<sub>3</sub> · H<sub>2</sub>O) at 700°C for 3 h in air. The preparation techniques of bayerite and boehmite are described in a previous paper [8]. CuO was obtained by the thermal decomposition of basic cupric carbonate,  $CuCO<sub>3</sub> \cdot Cu(OH)$ ,  $\cdot H<sub>2</sub>O$ , at 700°C for 1 h in air. CuO and Al<sub>2</sub>O<sub>3</sub> samples were sieved to obtain  $-300$  mesh fraction and equimolar amounts of them were mixed for 1 h in an agate mortar. Pure CuAl,  $O_4$  was prepared as follows. After heating a mixture of  $CuO/\gamma-Al_2O_3$  (1.1/1 mole ratio) at 1000°C for 5 h in air, unreacted CuO was removed from the product by extraction with a hot  $NH<sub>4</sub>Cl-NH<sub>4</sub>OH$  solution, the product was washed and dried. X-ray diffraction of the product obtained revealed the presence of well-crystallized CuAl<sub>2</sub>O<sub>4</sub> alone. All reagents used were of GR grade and were supplied by Kanto Chemical Co.

Simultaneous TG-DTA measurements of samples ( < 20 mg) were carried out using a Rigaku Denki thermoanalyzer (model 8085) at a heating (or cooling) rate of  $10^{\circ}$ C min<sup>-1</sup> in air.

High-temperature X-ray diffraction of the  $CuO-Al<sub>2</sub>O<sub>3</sub>$  systems was conducted with Ni-filtered Cu  $K_a$  radiation (40 kV, 20 mA) and a scanning speed of  $2^{\circ}$  min<sup>-1</sup> using a Geigerflex 2013 (Rigaku Denki Co.), to which a furnace for heating the sample (type A-4, 2311) was attached. During the heating of the sample at a rate of  $3.4-3.6^{\circ}$ C min<sup>-1</sup> up to  $1180^{\circ}$ C in air, the intensity of the following X-ray diffraction lines was recorded repeatedly in the range  $2\theta = 34-40^{\circ}$ : CuO (111), (111);  $\eta$ - and  $\gamma$ -Al<sub>2</sub>O<sub>3</sub> (311);  $\alpha$ -Al<sub>2</sub>O<sub>3</sub> (104), (110); CuAl<sub>2</sub>O<sub>4</sub> (311); CuAlO<sub>2</sub> (102), (101); Cu<sub>2</sub>O (111).

## RESULTS AND DISCUSSION

The information about individual thermal changes of  $A1_2O_3$ , CuO and CuAl<sub>3</sub>O<sub>4</sub> will serve in understanding the reaction process in the CuO-Al<sub>3</sub>O<sub>3</sub> system. The DTA curves of  $\eta$ - and  $\gamma$ -Al<sub>2</sub>O<sub>3</sub> are shown in a previous communication [9]. An exothermic peak corresponding to the transformation to  $\alpha$ -Al<sub>2</sub>O<sub>3</sub> appeared at 1277°C for  $\eta$ -Al<sub>2</sub>O<sub>3</sub> and at 1235°C for  $\gamma$ -Al<sub>2</sub>O<sub>3</sub>.

Figure 1 shows TG and DTA curves of the heating and cooling processes for CuO in the range 800-1150°C in air. On heating, two endothermic peaks appear at 1029 and 1115°C. The peak at 1029°C is accompanied by a weight loss of 10.2 wt% in TG, which agrees approximately with that of 10.06 wt% due to the thermal decomposition of CuO

$$
4 CuO = 2 Cu2O + O2
$$
 (1)

In fact, the X-ray diffraction of the sample, which was heated to 1055°C and then cooled to room temperature, revealed the presence of  $Cu<sub>2</sub>O$  and CuO. The formation of CuO results from the re-oxidation of  $Cu<sub>2</sub>O$  during the cooling of the sample in air, i.e., the backward reaction of reaction (1), which will be described in detail later. The peak at  $1115^{\circ}$ C is presumed to correspond to the melting of  $Cu<sub>2</sub>O$ , since the sample was observed to be in a molten state when heated to 115O'C. This melting resulted in a weight increase of about 1.8 wt% in TG. The weight increase in TG was also observed by Endoh et al. [10]. From the phase diagram of the  $RO-R_2O$ binary system containing a gaseous component [ll], it is found that the



Fig. 1. TG  $(- \cdots - )$  and DTA  $(- \cdots - )$  heating and cooling curves of CuO.

melting of Cu,O occurs with a pick-up of oxygen. On cooling, the DTA curve shows two exothermic peaks at 1067 and 995"C, the former is extraordinarily sharp ( $\Delta T = 6^{\circ}C$ ) and the latter is broad. The peak at  $1067^{\circ}$ C corresponds to the solidification of Cu<sub>2</sub>O melt, since the weight loss of about 2 wt $\%$  observed in TG is approximately comparable to the release of oxygen picked up when the melting of  $Cu<sub>2</sub>O$  occurred at 1115°C on heating. With a further decrease in temperature, a progressive increase in weight starts at 995°C or below, which will be due to the air re-oxidation of Cu,O to CuO. The X-ray diffraction of the sample cooled to room temperature revealed the presence of  $Cu<sub>2</sub>O$  and  $CuO$ . The intensity of the diffraction line of the sample showed that the fractional formation of CuO was much lower on cooling from 1150°C than from 1055°C where Cu<sub>2</sub>O did not melt. Microscopic observation showed that the bulk of the sample cooled from



Fig. 2. High-temperature X-ray curve  $(A)$ , and  $TG$   $(\cdots)$  and  $DTA$   $(\cdots)$  curves  $(B)$ **of CuAl,O,.** 

 $1150^{\circ}$ C to room temperature was a red color, which was covered with a black product layer of CuO. Therefore, it is considered that on cooling the  $Cu<sub>2</sub>O$  melt from 1150°C, the oxidation of  $Cu<sub>2</sub>O$  is inhibited by an impermeable layer of CuO formed on the Cu,O.

Figure 2 shows the high-temperature X-ray curve (A), and TG and DTA curves (B) of CuAl<sub>2</sub>O<sub>4</sub>. As can be seen from Fig. 2A, the intensity of the CuAl<sub>2</sub>O<sub>4</sub> (311) line begins to decrease gradually at about 1100 $^{\circ}$ C and the CuAlO<sub>2</sub> (102) line begins to appear at about 1140 °C, indicating the occurrence of the thermal decomposition of CuAl,O,

$$
4 CuAl2O4 = 4 CuAlO2 + 2 Al2O3 + O2
$$
 (2)

In the TG curve (Fig. 2B), the weight decrease occurs gradually at about 1050 "C and predominates at about 1200 "C. The weight decrease in the range  $800-1300$  °C was observed to be 4.2 wt%, which agrees with the theoretical weight loss of 4.41 wt% in reaction (2). On the DTA curve (Fig. 2B) two endothermic peaks appear at 1207 and 1258°C. The former will correspond to reaction (2) because of the agreement with the temperature of predominant weight loss in TG. The latter, on the contrary, shows a slight increase in weight. The temperature of 1258°C agrees approximately with 1260 [l] or 1238°C [2] which is reported for the incongruent melting of  $CuAlO<sub>2</sub>$  with a pick-up of oxygen,

$$
2\text{ CuAlO}_2 = \text{Al}_2\text{O}_3 + \text{liquid} \tag{3}
$$

Figure 3 shows the high-temperature X-ray curve (A), and TG and DTA curves (B) of the CuO- $\eta$ -Al<sub>2</sub>O<sub>3</sub> system. The curves below 700 $\degree$ C in Fig. 3A and 800°C in Fig. 3B are not shown, because no change was observed. In Fig. 3A the intensity of the CuO (111) and  $(111)$  lines begins to decrease at about 850°C and the CuAl<sub>2</sub>O<sub>4</sub> (311) line begins to appear. Since CuAl<sub>2</sub>O<sub>4</sub> and  $\eta$ -Al<sub>2</sub>O<sub>3</sub> have a spinel structure and their (311) lines overlap, it was impossible to determine precisely the initial temperature of CuAl,O, formation. With a further rise in temperature, the intensity of the CuAl<sub>2</sub>O<sub>4</sub> (311) line increases and reaches a maximum at 1130°C, while that of the CuO (111) and  $(\overline{1}11)$  lines decreases and disappears at 1120°C. Therefore, it is found that the formation of  $CuAl<sub>2</sub>O<sub>4</sub>$  spinel proceeds in the range 800-1130°C

$$
CuO + Al2O3 = CuAl2O4
$$
 (4)

The further rise in temperature leads to a decrease in the intensity of the CuAl, $O_4$  (311) line and an appearance of the CuAlO<sub>2</sub> (102) line. This behavior, as well as that in Fig. 2A, shows that the thermal decomposition of CuAl<sub>2</sub>O<sub>4</sub> (reaction 2) occurs above 1130°C.

On the other hand, the DTA curve in Fig. 3B shows four endothermic peaks at 1040, 1108, 1221 and 1242°C. The endothermic reaction at  $1040^{\circ}$ C occurs with a weight decrease. By comparison with Fig. 1, this reaction can



Fig. 3. High-temperature X-ray curve (A), and TG (- - - - - -) and DTA (- ) curves (B). of the CuO- $\eta$ -Al<sub>2</sub>O<sub>3</sub> system.

be considered to correspond to the thermal decomposition (reaction 1) of unreacted CuO in reaction (4). The fractional formation of CuAl<sub>2</sub>O<sub>4</sub>( $\alpha$ ) was calculated to be ca. 80% on the basis of the weight loss due to unreacted CuO in TG. The resulting Cu,O melted with a small endothermic peak at 1108°C in DTA and with a small weight increase by a pick-up of oxygen in TG. This Cu,O formation, however, was not detected by X-ray diffraction and CuO existed up to  $1120^{\circ}$ C (Fig. 3A). Such a discrepancy in the results obtained by TG, DTA and X-ray diffraction may be attributable to differences in measuring conditions and sensitivity of these experimental techniques. With a further rise in temperature, the weight decrease begins at about 1130°C and predominates at 1200°C. In DTA two small endothermic peaks appear at 1221 and 1242°C. This behavior in TG and DTA is similar to that of  $CuAl<sub>2</sub>O<sub>4</sub>$  in Fig. 2B, though there are some differences in peak temperature and size. As described above, the high-temperature X-ray curve above 1130°C in Fig. 3A is also similar to that in Fig. 2A. Therefore, it is assumed from the above results that the endothermic reactions at 1221 and  $1242^{\circ}$ C correspond to reactions (2) and (3), respectively. The weight loss of 4.4 wt% was observed in the range  $800-1300$ °C, which agreed well with that of 4.41 wt% calculated on the basis of reactions (1) or (2) in the CuO- $\eta$ -Al,O<sub>3</sub> system.

Figure 4 shows the high-temperature X-ray, curve (A), and TG and DTA curves (B) of the CuO- $\gamma$ -Al<sub>2</sub>O<sub>3</sub> system. The change in intensity of each



Fig. 4. High-temperature X-ray curve  $(A)$ , and TG  $(- \cdots)$  and DTA  $(\underline{\hspace{1cm}})$  curves  $(B)$ of the  $CuO - \gamma$ -Al<sub>2</sub>O<sub>3</sub> system.

compound in Fig. 4A is very similar to that in the  $CuO-\eta$ -Al<sub>2</sub>O<sub>3</sub> system shown in Fig. 3A. The TG and DTA curves in Fig. 4B are also similar to those in Fig. 3B, though there are differences in temperature and size of the two endothermic peaks at higher temperatures which correspond to reactions (2) and (3). Because of the similarity of the high-temperature X-ray, TG and DTA curves between Figs. 3 and 4, it can be concluded that the reaction behavior in the CuO- $\gamma$ -Al<sub>2</sub>O<sub>3</sub> system is similar to that in the CuO- $\eta$ -Al<sub>2</sub>O<sub>3</sub> system.

Figure 5 shows the high-temperature X-ray curve (A), and TG and DTA curves (B) of the CuO- $\alpha$ -Al<sub>2</sub>O<sub>3</sub> system. The intensity of the CuO (111) and (111) lines begins to decrease steeply at  $1030^{\circ}$ C and then disappears at 112O"C, which indicates the thermal decomposition of CuO. The intensity of the  $\alpha$ -Al<sub>2</sub>O<sub>3</sub> (104) line decreases slowly above 1040 °C. On the other hand, corresponding to the decrease in intensity of CuO and  $\alpha$ -Al<sub>2</sub>O<sub>3</sub>, the lines of  $Cu<sub>2</sub>O$  (111) and CuAlO<sub>2</sub> (101), (102) begin to appear and increase in intensity. The line of  $Cu<sub>2</sub>O$  (111) was observed to overlap with that of CuAlO, (101). The intensity of this overlapped line decreases after a maximum at  $1120^{\circ}$ C, which results from the melting of Cu<sub>2</sub>O. Since the lines of  $\alpha$ -Al<sub>2</sub>O<sub>3</sub> (110) and CuAlO<sub>2</sub> (102) also overlap with each other, it was impossible to determine a precise beginning temperature of CuAlO, formation. From the above results, it can be considered that after reaction (1), reaction (5) occurs successively above 1000 $^{\circ}$ C in the CuO- $\alpha$ -Al<sub>2</sub>O<sub>3</sub> system,

$$
Cu2O + Al2O3 = 2 CuAlO2
$$
 (5)

Furthermore, an unknown line was observed at 1070°C or above. X-ray diffraction of the sample cooled to room temperature after runs revealed the presence of some unknown lines at  $2\theta = 37.2$ , 39.7, 55.0 and 66.1°. These lines were also observed in the systems  $CuO-\eta$ -Al<sub>2</sub>O<sub>3</sub> and  $CuO-\gamma$ -Al<sub>2</sub>O<sub>3</sub> when heated to  $1250$  or  $1300\degree$ C and then cooled to room temperature.

Some experiments in the CuO- $\alpha$ -Al<sub>2</sub>O<sub>3</sub> system were performed under the conditions of a more rapid heating rate (i.e., ca.  $9^{\circ}$ C min<sup>-1</sup>) and air flow  $(100 \text{ ml } \text{min}^{-1})$ . In the former case, the change in the intensity of each compound occurred at a temperature 20-30°C higher. In the latter case, the result obtained was quite similar to that in static air shown in Fig. 5A. It was found that the reaction temperatures in the CuO- $\alpha$ -Al<sub>2</sub>O<sub>3</sub> system (Fig. 5A) disagreed with those reported by Bessonov et al. [7]; for example, they reported that CuO decomposed to  $Cu<sub>2</sub>O$  at 800°C and CuAlO<sub>2</sub> formed at 930°C. According to the isothermal experiments in vacuum or in He flow (30 ml min<sup>-1</sup>) in the CuO- $\eta$ -Al<sub>2</sub>O<sub>3</sub> and CuO- $\gamma$ -Al<sub>2</sub>O<sub>3</sub> systems (not shown in the figure), it was observed that not only  $CuAl<sub>2</sub>O<sub>4</sub>$  but also  $Cu<sub>2</sub>O$  and CuAlO<sub>2</sub> formed even when heated at  $800^{\circ}$ C. Therefore, it is considered that a disagreement between the present results and those of Bessonov et al. arises from the difference in the partial pressure of oxygen in a reaction atmosphere.



Fig. 5. High-temperature X-ray curve (A), and TG ( $---$ ) and DTA ( $---$ ) curves (B) of the CuO- $\alpha$ -Al<sub>2</sub>O<sub>3</sub> system.

In the TG and DTA curves (Fig. 5B), an endothermic peak appears at 1045°C with a weight loss, which corresponds to the decomposition of CuO to Cu<sub>2</sub>O. A part of the resulting Cu<sub>2</sub>O reacts immediately with  $\alpha$ -Al<sub>2</sub>O<sub>3</sub> to form CuAlO<sub>2</sub> (Fig. 5A), and the remainder melts at  $1102^{\circ}$ C with a pick-up of oxygen. Overlapping with the endothermic peak at 1102'C, a sharp exothermic peak appears at 1112°C. This exothermic peak might be attributable to some reaction in the presence of  $\alpha$ -Al<sub>2</sub>O<sub>3</sub>, because it was not

observed in the systems  $CuO-\eta$ -Al<sub>2</sub>O<sub>3</sub> and  $CuO-\gamma$ -Al<sub>2</sub>O<sub>3</sub>. However, when the CuO- $\alpha$ -Al<sub>2</sub>O<sub>3</sub> system was heated at 5<sup>o</sup>C min<sup>-1</sup> this exothermic peak did not appear and only a small endothermic peak appeared at 1103°C. With a further rise in temperature, an endothermic peak appears at 1218°C which corresponds to reaction (3), i.e., the incongruent melting of CuAlO,. As can be seen from Figs. 3B-5B,  $\eta$ -,  $\gamma$ - and  $\alpha$ -Al<sub>2</sub>O<sub>3</sub> systems produce the difference in the temperature and size of an endothermic peak corresponding to the incongruent melting of CuAlO,. It may depend on the reactivity of CuAlO, formed in each system or on the phase and crystallinity of  $Al_2O_3$  present in each system which can act as nuclei when new  $Al_2O_3$  precipitates from the melt.

From the above results, it has been found that the high-temperature X-ray curve, and TG and DTA curves differ remarkably in the CuO- $\eta$ -Al,O<sub>3</sub>, CuO- $\gamma$ -Al<sub>2</sub>O<sub>3</sub> and CuO- $\alpha$ -Al<sub>2</sub>O<sub>3</sub> systems. This difference can be explained by the fact that during heating of the CuO- $\eta$ -Al<sub>2</sub>O<sub>3</sub> and CuO- $\gamma$ -Al<sub>2</sub>O<sub>3</sub> systems to 1000°C, CuAl<sub>2</sub>O<sub>4</sub> formed, but it did not form in the CuO- $\alpha$ -Al<sub>2</sub>O<sub>3</sub> system. Therefore, the formation of  $CuAl<sub>2</sub>O<sub>4</sub>$  is dependent on the difference in the reactivity of  $\eta$ -,  $\gamma$ - and  $\alpha$ -Al<sub>2</sub>O<sub>3</sub>. In the case of  $\alpha$ -Al<sub>2</sub>O<sub>3</sub>, during  $CuAl<sub>2</sub>O<sub>4</sub>$  formation, the packing mode of the oxygen ions has to change from h.c.p. to f.c.c. due to its corundum structure, while this is not the case for  $\eta$ - and  $\gamma$ -Al<sub>2</sub>O<sub>3</sub> because they have a spinel structure. Furthermore, it was observed in the CuO-Al<sub>2</sub>O<sub>3</sub> systems that on heating the melting of Cu<sub>2</sub>O occurred and on cooling the backward reactions of reactions (1) and (3) proceeded. Therefore, the X-ray diffraction of samples which were cooled to room temperature from the various temperatures in TG and DTA experiments did not necessarily reveal the phases that existed at high temperatures. Because the high-temperature X-ray diffraction apparatus can measure continuously the phases existing at high temperatures in situ, it is a very useful apparatus for the analysis of reaction behaviors. When combined with the results of TG and DTA experiments, more precise information about the reaction process is obtained.

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